

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT4809136

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| | |
| Name | Execution Date |
| TOYOTOSHI MURATA | 02/05/2018 |
| KAZUHITO YAMAMOTO | 02/05/2018 |
| RECEIVING PARTY DATA | |
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| State/Country: | JAPAN |
| Postal Code: | 110-0015 |
| PROPERTY NUMBERS Total: 1 | |
| | |
| Property Type | Number |
| Application Number: | 15024660 |
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| SIGNATURE: | /Thomas E. Thompkins, Jr./ |
| DATE SIGNED: | 02/05/2018 |
| Total Attachments: 2 | |
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**ASSIGNMENT FOR
NONPROVISIONAL UTILITY OR DESIGN PATENT APPLICATION**

Title of Invention:
METHOD, SYSTEM AND TARGET FOR SETTING REFERENCE POINTS ON CONSTRUCTION

This assignment is directed to:

- The attached application having a docket number and title identified above, or
 United States patent application number

15/024,660

filed on

Jul 5, 2016

Assignor(s): The Assignor(s) is/are the undersigned inventor(s). The inventor(s) named below has/have made certain inventions, improvements, and/or discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application.

Assignee: The Assignee is **BIG SURVEY & DESIGN CO. LTD.**, a corporation of Japan having a place of business at **1-26-8, Higashi-ueno, Taito-ku, Tokyo 110-0015 JAPAN** (herein referred to as the "ASSIGNEE"). The term "ASSIGNEE" used herein includes successors, legal representatives, and assigns of the ASSIGNEE. The ASSIGNEE desires to acquire the entire worldwide right, title, and interest in and to the invention and in and to any and all patent applications and patents obtained from the Invention.

As an undersigned inventor, I hereby assign to the ASSIGNEE my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefrom in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, granted for the invention, to the ASSIGNEE, and I authorize and request foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE. The entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made. I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, for the ASSIGNEE, whenever requested by the ASSIGNEE.

As an undersigned inventor, I acknowledge prior and ongoing obligations to sell, assign, and/or transfer my rights in the Invention to the ASSIGNEE. I have not sold, assigned, or otherwise transferred my rights in the Invention to another, and I am under no obligation to sell, assign, or otherwise transfer my rights in the Invention to another. I also hereby grant the ASSIGNEE, the right to insert in this Assignment any further identification (including, but not limited to, patent application number and filing date) which may be necessary or desirable for recording this Assignment.

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